Supplementary Information

Electrical Charge-Induced Selective Ion Permeation in HfO₂/Porous Nickel

Silicide Hierarchical Structures

Chih-Chung Lai^{1†}, Chung-Han Lu^{1†}, Hsuan-Chu Chen¹, Chia-Kai Lin², Fan-Gang Tseng^{2,3},

and Yu-Lun Chueh¹*

¹Department of Materials Science and Engineering, National Tsing Hua University, Hsinchu,

30013, Taiwan, ROC

²Department of Engineering and System Science, National Tsing Hua University, Hsinchu,

30013, Taiwan, ROC

³Division of Mechanics, Research Center for Applied Sciences, Academia Sinica, Taiwan,

ROC

*E-mail: ylchueh@mx.nthu.edu.tw

[†] These authors contributed equally to this work.



Figure S1 (a-f) SEM images of annealed Au thin films on p-Si substrate at different conditions for formation of Au NP arrays.



Figure S2 Heating profile for the formation of the NiSi conductive phase on Ni/porous Si structures.



Figure S3 Calibration of electrolyte conductivity versus salt concentration.

Flexural strength of porous NiSi and AAO membranes by three-point flexural test

In general, the flexural strength of single crystalline silicon dice is about 300-900 MPa, varied the different dimension and orientation of crystals. Our experimental results as shown in Table 1 revealed a lower flexural strength of PNiSi materials due to the high porosity of PSi structures. However, it still appears improvement of flexural strength of membrane materials once porous NiSi structures were used.